

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
JIE ZHANG	04/08/2020
XIAOLI LIU	04/08/2020
FENGZHEN SUN	04/08/2020
DELIN LI	04/08/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SOLTRIUM ADVANCED MATERIALS TECHNOLOGY, LTD. SHENZHEN
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<b>Internal Address:</b>	9-5F BAONENG SCIENCE PARK
<b>City:</b>	SHENZHEN, GUANGDONG
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	518999
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16840344
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	6502910099
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<b>Correspondent Name:</b>	FANG WU
<b>Address Line 1:</b>	10641 PASEO ALLEGRIA AVE
<b>Address Line 4:</b>	SAN DIEGO, CALIFORNIA 92127
<b>ATTORNEY DOCKET NUMBER:</b>	ST0702-001010US
<b>NAME OF SUBMITTER:</b>	FANG WU
<b>SIGNATURE:</b>	/Fang Wu/
<b>DATE SIGNED:</b>	04/08/2020
<b>Total Attachments: 2</b>	
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**ASSIGNMENT OF PATENT APPLICATION**

WHEREAS, the below named individual, hereinafter referred to as "ASSIGNOR," is the inventor of the invention described and set forth in the below-identified application for a Patent of the United States:

Title of Invention:     **CONDUCTIVE PASTE FOR SEMICONDUCTOR  
                                  DEVICE AND PREPARATION METHOD**

Filing Date:            04/04/2020

Application No.:        16/840,344

WHEREAS, **Soltrium Advanced Materials Technology, Ltd. Shenzhen** of 9-5F Baoneng Science Park, #1 Qingxiang Rd, Longhua District, Shenzhen, Guangdong 518999 China, hereinafter referred to as "ASSIGNEE," is desirous of acquiring ASSIGNOR' entire right, title and interest in, to and under the said invention and the said application:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by ASSIGNOR, ASSIGNOR has sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, ASSIGNOR' entire right, title and interest in, to and under the said invention and the said United States provisional application, and all applications claiming priority thereto under 35 U.S.C. §119(e) and divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

AND ASSIGNOR HEREBY authorizes and requests the Commissioner for Patents and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument;

AND ASSIGNOR HEREBY covenants and agrees that he has full right to convey the entire interest herein assigned, and that they have not executed, and will not execute, any agreement in conflict herewith;

AND ASSIGNOR HEREBY further covenants and agrees that he will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to ASSIGNOR respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, ASSIGNOR HEREBY has signed his name on the dates indicated.

2020.4.8  
Date:

Jie Zhang  
Name: Jie Zhang

2020.4.8  
Date:

Xiaoli Liu  
Name: Xiaoli Liu

2020.4.8  
Date:

Fengzhen Sun  
Name: Fengzhen Sun

2020.4.8  
Date:

DL  
Name: Delin Li